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IRLI620G, SiHLI620G

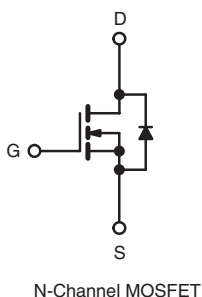
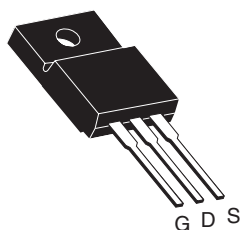
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY

| | | |
|---------------------------|------------------|------|
| V_{DS} (V) | 200 | |
| $R_{DS(on)}$ (Ω) | $V_{GS} = 5.0$ V | 0.80 |
| Q_g (Max.) (nC) | 16 | |
| Q_{gs} (nC) | 2.7 | |
| Q_{gd} (nC) | 9.6 | |
| Configuration | Single | |

TO-220 FULLPAK



FEATURES

- Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Dist. 4.8 mm
- Logic-Level Gate Drive
- $R_{DS(on)}$ Specified at $V_{GS} = 4$ V and 5 V
- Fast Switching
- Ease of paralleling
- Lead (Pb)-free Available



RoHS*
COMPLIANT

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION

| | |
|----------------|-----------------------------|
| Package | TO-220 FULLPAK |
| Lead (Pb)-free | IRLI620GPbF SiHLI620G-E3 |
| SnPb | IRLI620G SiHLI620G |

ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$, unless otherwise noted

| PARAMETER | SYMBOL | LIMIT | UNIT |
|--|--------------------------|-----------------------------------|---------------------|
| Drain-Source Voltage | V_{DS} | 200 | V |
| Gate-Source Voltage | V_{GS} | ± 10 | |
| Continuous Drain Current | V_{GS} at 5.0 V | $T_C = 25^\circ\text{C}$ I_D | A |
| | | $T_C = 100^\circ\text{C}$ 2.6 | |
| Pulsed Drain Current ^a | | I_{DM} | 16 |
| Linear Derating Factor | | 0.24 | W/ $^\circ\text{C}$ |
| Single Pulse Avalanche Energy ^b | | E_{AS} | 62 mJ |
| Repetitive Avalanche Current ^a | | I_{AR} | 4.0 A |
| Repetitive Avalanche Energy ^a | | E_{AR} | 3.0 mJ |
| Maximum Power Dissipation | $T_C = 25^\circ\text{C}$ | P_D | 30 W |
| Peak Diode Recovery dV/dt ^c | | dV/dt | 5.0 V/ns |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to + 150 | $^\circ\text{C}$ |
| Soldering Recommendations (Peak Temperature) | for 10 s | 300 ^d | |
| Mounting Torque | 6-32 or M3 screw | 10 | lbf · in |
| | | 1.1 | N · m |

Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 25$ V, starting $T_J = 25^\circ\text{C}$, $L = 5.8$ mH, $R_G = 25\ \Omega$, $I_{AS} = 4.0$ A (see fig. 12).
- $I_{SD} \leq 5.2$ A, $dI/dt \leq 95$ A/ μs , $V_{DD} \leq V_{DS}$, $T_J \leq 150^\circ\text{C}$.
- 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------------|------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R_{thJA} | - | 65 | °C/W |
| Maximum Junction-to-Case (Drain) | R_{thJC} | - | 4.1 | |

| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | |
|---|----------------------------------|--|--|------|------|-------|------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 μA | | 200 | - | - | V |
| V _{DS} Temperature Coefficient | ΔV _{DS} /T _J | Reference to 25 °C, I _D = 1 mA | | - | 0.27 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | | 1.0 | - | 2.0 | V |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 10 V | | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 200 V, V _{GS} = 0 V | | - | - | 25 | μA |
| | | V _{DS} = 160 V, V _{GS} = 0 V, T _J = 125 °C | | - | - | 250 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 5.0 V | I _D = 2.4 A ^b | - | - | 0.80 | Ω |
| | | V _{GS} = 4.0 V | I _D = 2.0 A ^b | - | - | 1.0 | |
| Forward Transconductance | g _{fs} | V _{DS} = 50 V, I _D = 3.1 A ^b | | 1.2 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5 | | - | 360 | - | pF |
| Output Capacitance | C _{oss} | | | - | 91 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 27 | - | |
| Total Gate Charge | Q _g | V _{GS} = 10 V | I _D = 5.2 A, V _{DS} = 160 V, see fig. 6 and 13 ^b | - | - | 16 | nC |
| Gate-Source Charge | Q _{gs} | | | - | - | 2.7 | |
| Gate-Drain Charge | Q _{gd} | | | - | - | 9.6 | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 100 V, I _D = 5.2 A, R _G = 9.0 Ω, R _D = 20 Ω, see fig. 10 ^b | | - | 4.2 | - | ns |
| Rise Time | t _r | | | - | 31 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 18 | - | |
| Fall Time | t _f | | | - | 17 | - | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | nH |
| Internal Source Inductance | L _S | | | - | 7.5 | - | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 4.0 | A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 16 | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 9.9 A, V _{GS} = 0 V ^b | | - | - | 1.8 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 5.2 A, dI/dt = 100 A/μs ^b | | - | 180 | 270 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 1.1 | 1.7 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D) | | | | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\%$.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

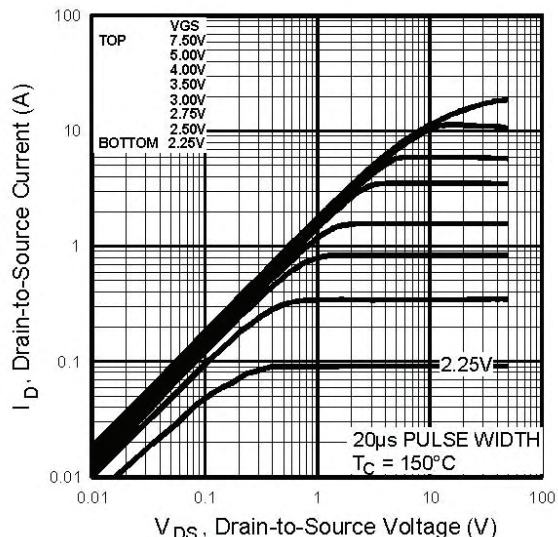


Fig. 1 - Typical Output Characteristics, $T_C = 25^\circ\text{C}$

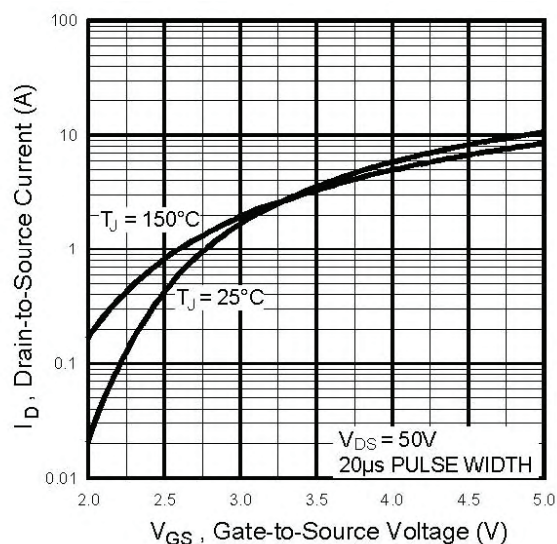


Fig. 3 - Typical Transfer Characteristics

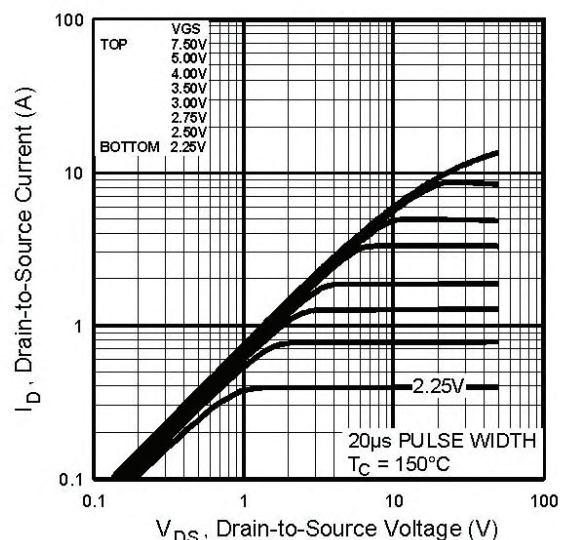


Fig. 2 - Typical Output Characteristics, $T_C = 150^\circ\text{C}$

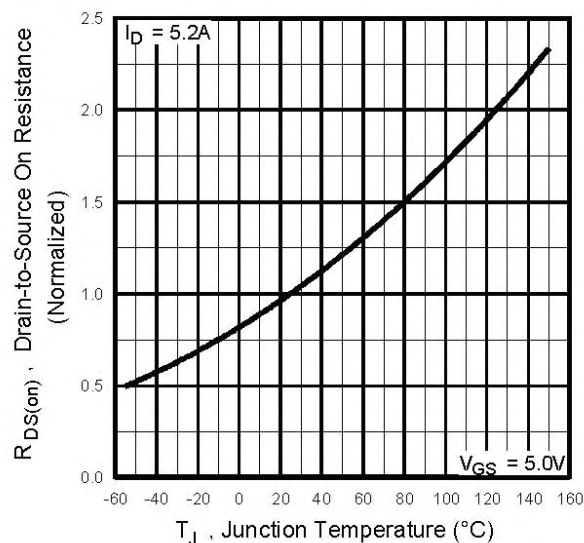
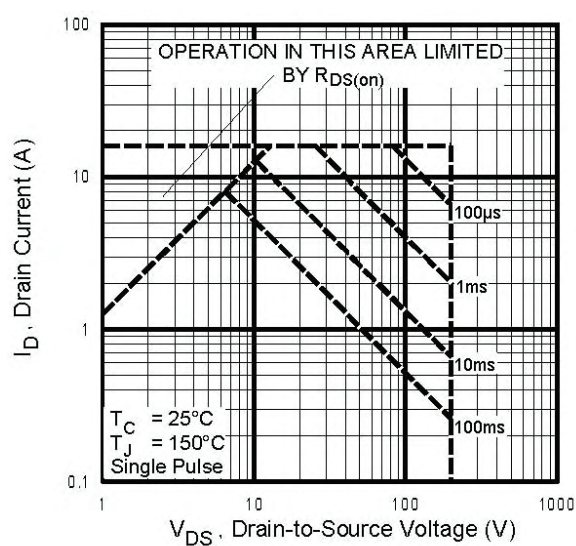
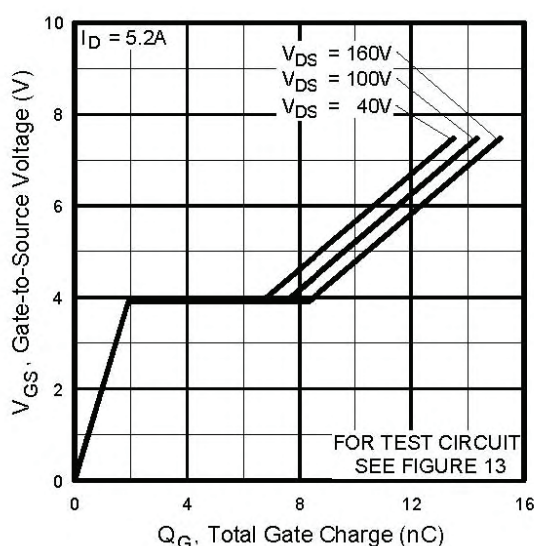
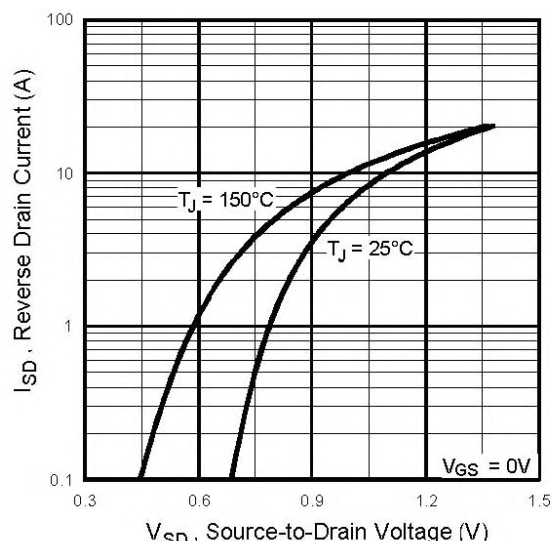
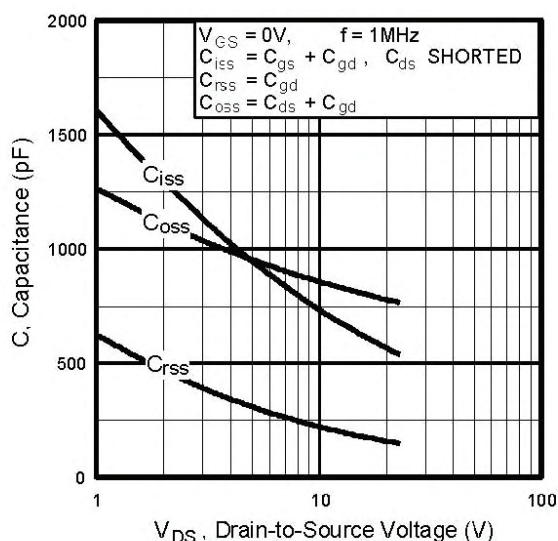


Fig. 4 - Normalized On-Resistance vs. Temperature

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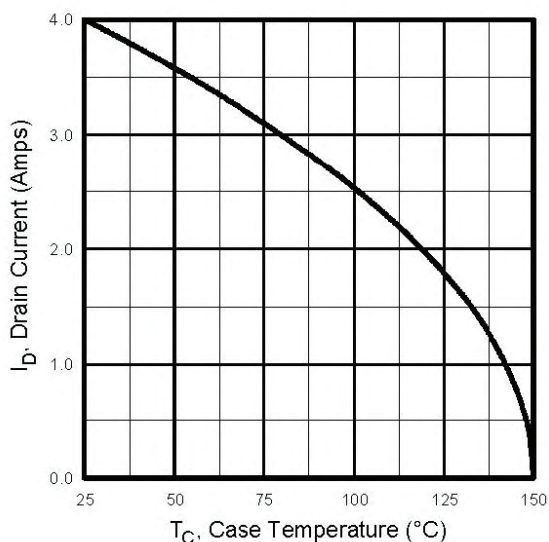


Fig. 9 - Maximum Drain Current vs. Case Temperature

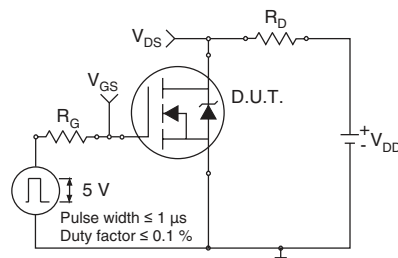


Fig. 10a - Switching Time Test Circuit

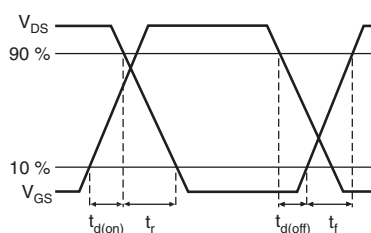


Fig. 10b - Switching Time Waveforms

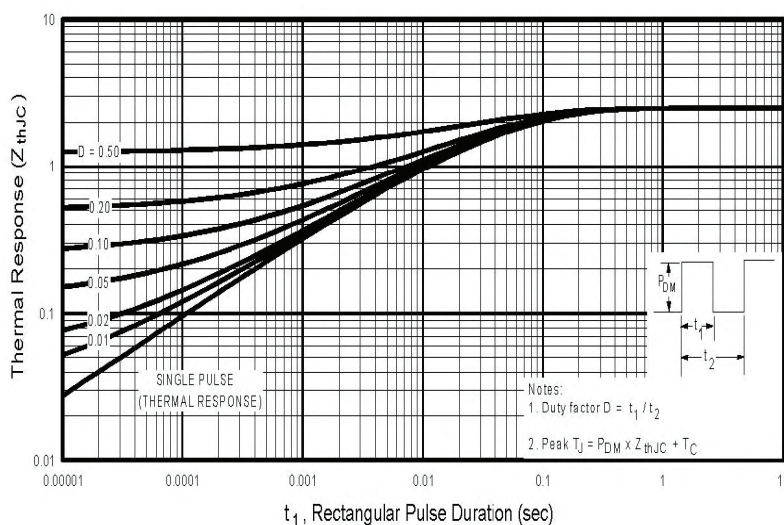


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

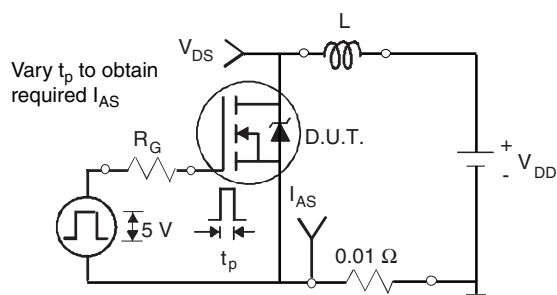


Fig. 12a - Unclamped Inductive Test Circuit

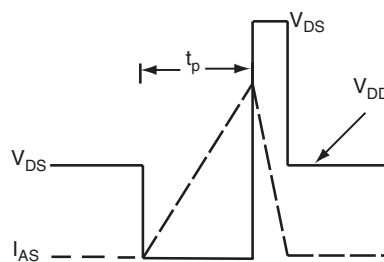


Fig. 12b - Unclamped Inductive Waveforms

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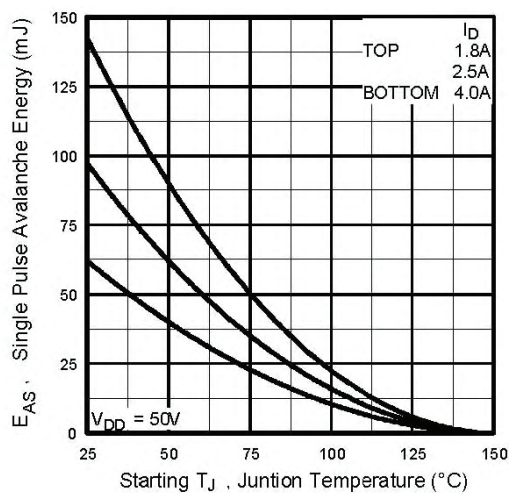


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

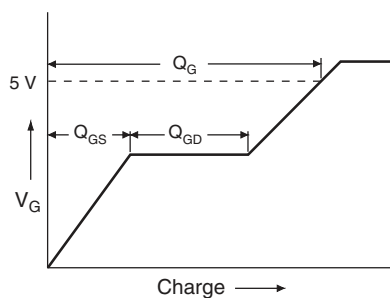


Fig. 13a - Basic Gate Charge Waveform

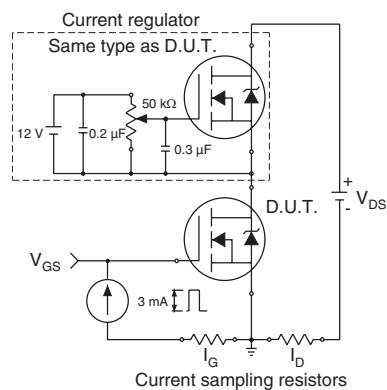


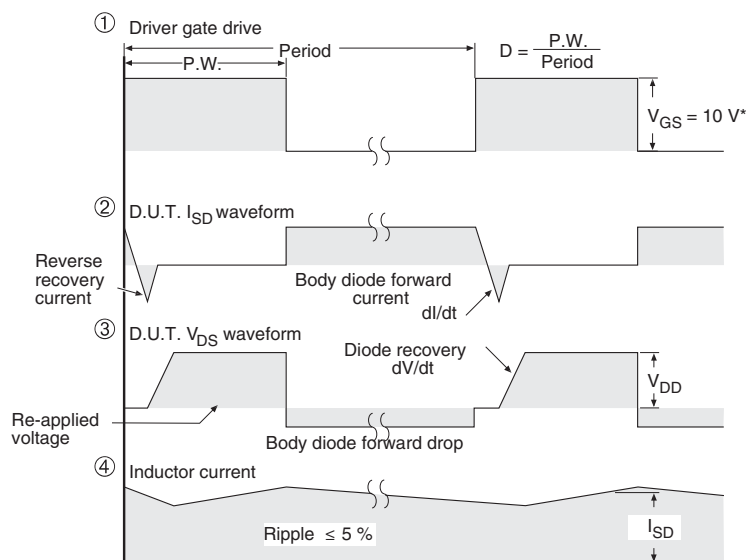
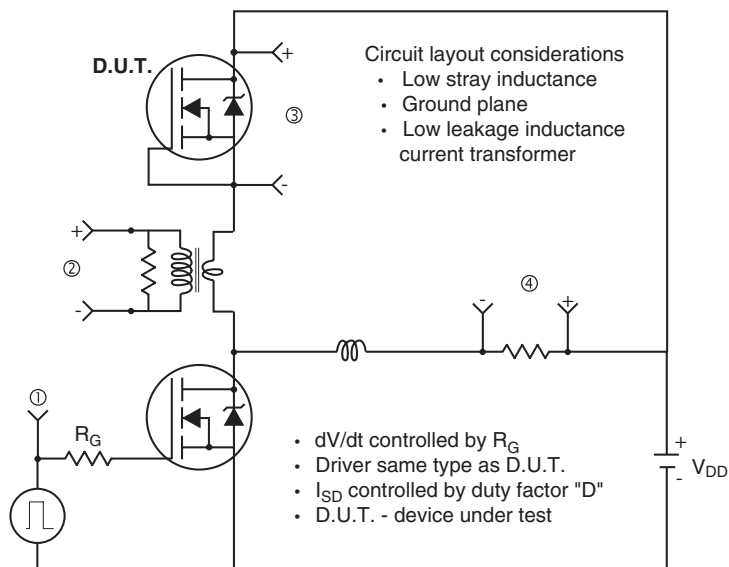
Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit



* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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